

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TETSUYA KOMOTO	09/11/2019
RECEIVING PARTY DATA	
Name:	JAPAN AVIATION ELECTRONICS INDUSTRY, LIMITED
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City:	TOKYO
State/Country:	JAPAN
Postal Code:	150-0043
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29712347
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NAME OF SUBMITTER:	MANABU KANESAKA
SIGNATURE:	/Manabu Kanesaka/
DATE SIGNED:	11/07/2019
Total Attachments: 1	
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ASSIGNMENT

For value received, I, Tetsuya KOMOTO having post office address at c/o Japan Aviation Electronics Industry, Limited, 21-1, Dogenzaka 1-chome, Shibuya-ku, Tokyo 150-0043, Japan hereby sell, assign and transfer to Japan Aviation Electronics Industry, Limited a corporation existing under the laws of Japan located at 21-1, Dogenzaka 1-chome, Shibuya-ku, Tokyo 150-0043, Japan and its successors, assigns, and legal representatives the entire right, title, and interest for all countries including the United States of America, in and to certain inventions relating to CONNECTOR described in application for Letters Patent of the United States, executed by me on this date, and all patents which may be granted therefor, and all divisions, reissues, continuations and extensions thereof, and authorize and request the Commissioner of Patents and Trademarks to issue all patents on said improvements or resulting therefrom to said Company as assignee of the entire interest, and covenant that I have full right so to do, and agree that I will communicate to said Company or its representatives any facts known to me respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said Company, its successors, assigns, and nominees, to obtain and enforce proper protection for said invention in the United States.

Signature Tetsuya Komoto Date September 11, 2019

Tetsuya KOMOTO